



RECOMMENDED PCB LAYOUT
TOLERANCE: ±0.05MM

- NOTES:
- MATERIAL:
HOUSING : LCP , UL94 V-0;
TERMINAL : COPPER ALLOY;
 - FINISHES:
TERMINAL:
1.27um MIN. NICKEL UNDERPLATING OVERALL;
0.38um MIN. GOLD PLATING ON CONTACT AREA;
0.05um MIN. GOLD FLASH PLATING ON SOLDERING TAIL AREA;
 - PRODUCT SPECIFICATION: PS-151130-0001;
 - PACKAGING SPECIFICATION: PK-151130-0001;
 - NO CIRCUIT ALLOWED UNDER CONNECTOR;
 - DATE CODE PRINTED: XXX;
DAY OF THE YEAR

SYMBOLS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		CURRENT REV DESC:					
▽ = 0	mm	SCALE	10:1						SALES DRAWING FOR 0.38MM HEIGHT BLOCK SIM CONNECTOR
▽ = 0	GENERAL TOLERANCES (UNLESS SPECIFIED)			EC NO: 615053			DOCUMENT NUMBER		
▽ = 0	ANGULAR TOL ± 3.0°			DRWN: EZHANG06 2019/04/03			SD-151130-0001		
▽ = 0	4 PLACES ±			CHK'D: AYIN 2019/04/14			DOC TYPE DOC PART REVISION		
▽ = 0	3 PLACES ±			APPR: AYIN 2019/04/14			PSD 001 A		
▽ = 0	2 PLACES ± 0.13			INITIAL REVISION:			MATERIAL NUMBER		
▽ = 0	1 PLACE ± 0.2			DRWN: HLWANG06 2014/11/25			CUSTOMER		
▽ = 0	0 PLACES ±			APPR: HLWANG06 2014/12/23			GENERAL MARKET		
▽ = 0	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			THIRD ANGLE PROJECTION		DRAWING		SHEET NUMBER	
▽ = 0				A3-SIZE		SERIES		1 OF 1	
				151130		1511300001			